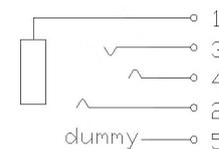
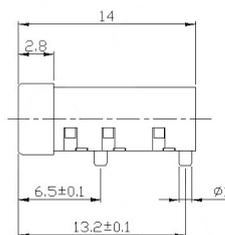
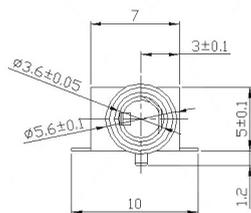
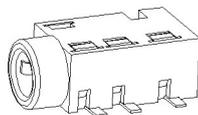


PCB LAYOUT



CIRCUIT DIAGRAM



	MATERIAL	PLATING
terminal 1	copper all oy	silver
terminal 2	copper all oy	silver
terminal 3	copper all oy	silver
terminal 4	copper all oy	silver
plastic	PA10T	

DSND	DATE	SCALE: N/A	MODEL TYPE: 3.5 PHONE JACK
DWN	DATE	VIEW:	PART NO.:
CHKD	DATE	UNIT: mm	DWG NO.:
APPD	DATE	SIZE: A4	PJ-327E-SMT
东莞市铀高电子制品有限公司			WEIGHT 1.0g
			SHEET 1/1
			REVISION A0

MARK	DESCRIPTION	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES
△X					ANGULAR ±5°
△X					L ≤ 4 ±0.2
△X					4 < L ≤ 16 ±0.3
					16 < L ≤ 63 ±0.4
					L > 63 ±0.5
REVISIONS					